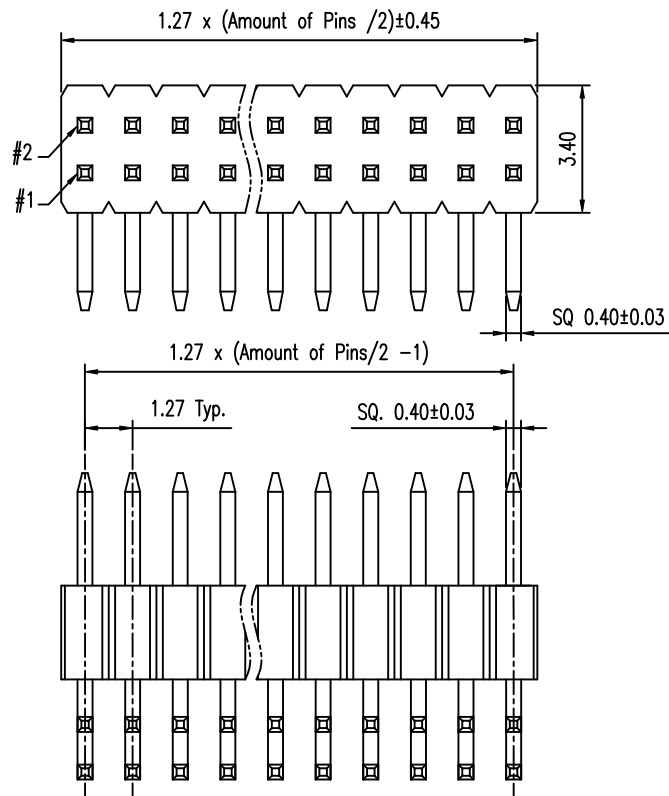
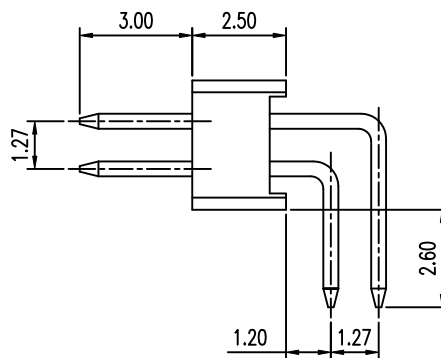


Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm



NOTE:

- MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, SQ=0.40±0.03MM
- FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u")MIN Ni OVER ALL
- SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 10 SEC. IN A WAVE SOLDER APPLICATION
WITH A PCB.
- PRODUCT NUMBERING:
20021112 - 0 0 0 XX X X LF

LEAD FREE

PLATING:

1: GOLD FLASH, ALL OVER
4: 0.25um(10U")GOLD AT CONTACT
8: 0.76um(30U")GOLD AT CONTACT

PACKING

T: TUBE

PIN COUNT

06,08,10,...98,A0
(6 - 100 EVERY EVEN PIN)

mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY		FCI  www.fciconnect.com			
ltr	ecn no	dr	date	linear	.X ± 0.38			projection 	title 1.27X1.27MM BTB,HEADER UNSHROUDED,RIGHT ANGLE,TH			
A	T09-1117	S.LIN	09/15/09		.XX ± 0.25							
B	T10-0012	S.LIN	09/15/09		.XXX ± 0.10							
				angles	0° ± 2°							
				dr	STERLING LIN	09/15/09	MM ←→	product family		585	code TWN	
				engr	STERLING LIN	09/15/09		size		dwg no		sheet 1 of 1
				chr	GARY HSIEH	09/15/09		scale				
				appd	JOSEPH HSIA	09/15/09	NA	A4	20021112			
sheet index	revision sheet		B 1									